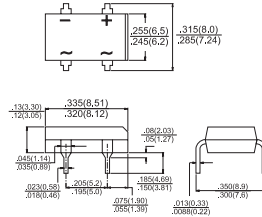




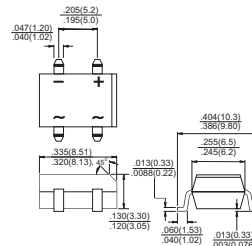
## DB



## Features

- ✦ UL Recognized File # E-96005
- ✦ Glass passivated junction
- ✦ Ideal for printed circuit board
- ✦ Reliable low cost construction utilizing molded plastic technique
- ✦ High temperature soldering guaranteed:  
260 °C / 10 seconds / 0.375" ( 9.5mm )  
lead length at 5 lbs., ( 2.3 kg ) tension
- ✦ Small size, simple installation  
Pure tin plated, Lead free. Leads solderable  
per MIL-STD-202, Method 208
- ✦ High surge current capability

## DBS



Dimensions in inches and (millimeters)

## Maximum Ratings and Electrical Characteristics

Rating at 25 °C ambient temperature unless otherwise specified.

Single phase, half wave, 60 Hz, resistive or inductive load.

For capacitive load, derate current by 20%

Type Number	Symbol	DB 101	DB 102	DB 103	DB 104	DB 105	DB 106	DB 107	Units
		DB 101S	DB 102S	DB 103S	DB 104S	DB 105S	DB 106S	DB 107S	
Maximum Recurrent Peak Reverse Voltage	$V_{RRM}$	50	100	200	400	600	800	1000	V
Maximum RMS Voltage	$V_{RMS}$	35	70	140	280	420	560	700	V
Maximum DC Blocking Voltage	$V_{DC}$	50	100	200	400	600	800	1000	V
Maximum Average Forward Rectified Current @ $T_A = 40^\circ C$	$I_{(AV)}$	1.0							A
Peak Forward Surge Current, 8.3 ms Single Half Sine-wave Superimposed on Rated Load (JEDEC method )	$I_{FSM}$	50							A
Maximum Instantaneous Forward Voltage @ 1.0A	$V_F$	1.1							V
Maximum DC Reverse Current @ $T_A=25^\circ C$ at Rated DC Blocking Voltage @ $T_A=125^\circ C$	$I_R$	10 500							$\mu A$ $\mu A$
Typical Thermal resistance ( Note 1 )	$R_{\theta JA}$ $R_{\theta JL}$	40 15							$^\circ C/W$
Operating Temperature Range	$T_J$	-55 to +150							$^\circ C$
Storage Temperature Range	$T_{STG}$	-55 to +150							$^\circ C$

- Notes:
1. Thermal Resistance from Junction to Ambient and from Junction to Lead Mounted On P.C.B. with 0.2" x 0.2" (5mm x 5mm) Copper Pads.
  2. DBS for Surface Mount Package.

RATINGS AND CHARACTERISTIC CURVES (DB101 THRU DB107)

FIG.1- MAXIMUM DERATING CURVE FOR OUTPUT RECTIFIED CURRENT

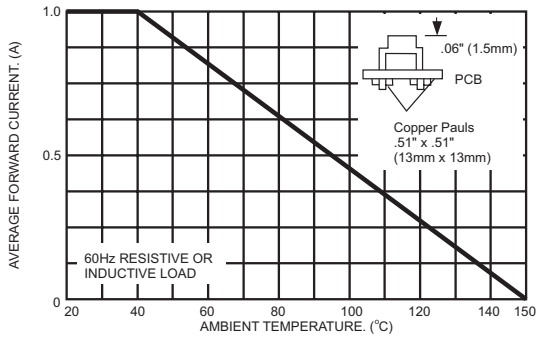


FIG.2- TYPICAL REVERSE CHARACTERISTICS PER BRIDGE ELEMENT

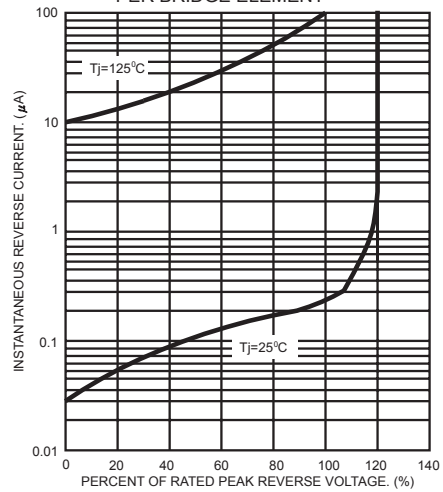


FIG.3- MAXIMUM NON-REPETITIVE PEAK FORWARD SURGE CURRENT

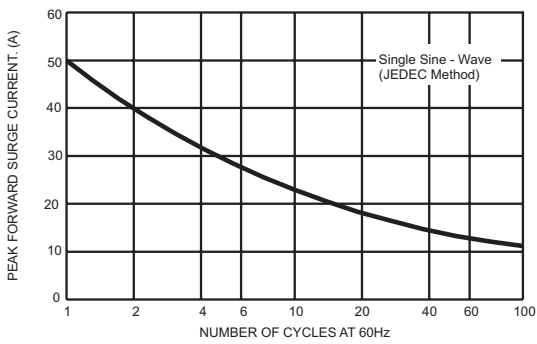


FIG.4- TYPICAL JUNCTION CAPACITANCE PER BRIDGE ELEMENT

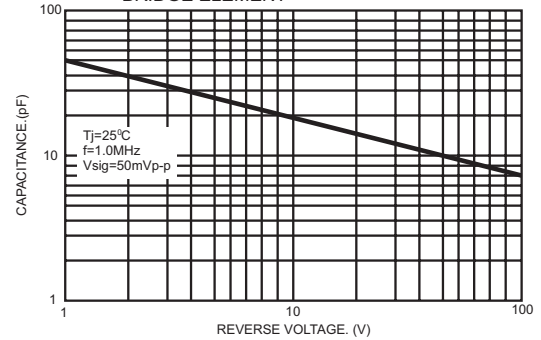


FIG.5- TYPICAL FORWARD CHARACTERISTICS PER BRIDGE ELEMENT

